

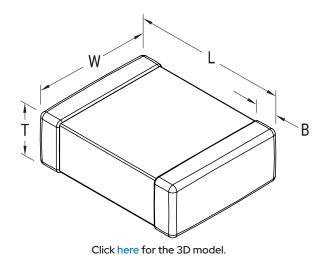
CBR04C369A5GAC

General Information

Specifications

Series

CBR-SMD RF COG, Ceramic, 3.6 pF, +/-0.05 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



Style SMD Chip Description SMD, Fixed, RF, Ultra High Q, Low ESR, Class I Features Ultra High Q, Low ESR, Class I RoHS Yes Termination Tin Marking No AEC-Q200 No Typical Component Weight 1.37 mg Notes Solder Reflow Only. Shelf Life 78 Weeks MSL 1

CBR-SMD RF COG

Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
т	0.5mm +/-0.05mm
В	0.25mm +0.05/-0.1mm

10000

T&R, 180mm, Plastic Tape

Packaging Specifications	
Packaging	

Packaging Quantity

Capacitance 3.6 pF +/-0.05 pF Tolerance Voltage DC 50 VDC **Dielectric Withstanding Voltage** 125 VDC -55/+125°C **Temperature Range** COG Temp. Coefficient 0.21% **Dissipation Factor** 0% Loss/Decade Hour Aging Rate Insulation Resistance 10 GOhms **Quality Factor** 472

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